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LIST OF PUBLICATION

Conference Paper:

1. C. K. Yu, D. C. Lu, T. C. Cheng and B. C. Tsai, Pool Boiling Heat Transfer from Artificial Micro-Cavities Surface in Dielectric Liquid FC-72, Proceedings of ASME International Mechanical Engineering Congress and R&D Expo Conference, 2004, IMECE2004-59297.
2. C. K. Yu, D. C. Lu, Experimental Study of Pool Boiling on Micro-Pin-Fin Array Heat Sink in Saturated FC-72, Fifth International Conference on Enhanced, Compact and Ultra-Compact Heat Exchangers: Science, Engineering and Technology, 2005.

Journal Paper:

1. C. K. Yu, D. C. Lu and T. C. Cheng, Pool Boiling Heat Transfer on Artificial Micro-Cavity Surfaces in Dielectric Fluid FC-72, Journal of Micromechanics and Microengineering, 16 (2006) 2092-2099.
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4. C. K. Yu and D. C. Lu, Pool Boiling Heat Transfer on Vertical Artificial Micro-cavity Array in Dielectric Fluid FC-72, Journal of Micromechanics and Microengineering, (submitted).